

# P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ)		
-30	0.018 @ V <sub>GS</sub> = -10 V	-9.6	-25		
	$0.030 @ V_{GS} = -4.5 V$	-7.5	-25		

#### s D 8 1 s D 2 7 s D 6 3 G D 4 5 Top View

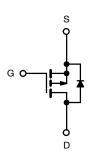
SO-8

#### FEATURES

- TrenchFET® Power MOSFET
- Advanced High Cell Density Process
- 100% R<sub>g</sub> Tested

### APPLICATIONS

- Load Switches
  - Notebook PCs
  - Desktop PCs



P-Channel MOSFET

Ordering Information: Si4835BDY Si4835BDY-T1 (with Tape and Reel) Si4835BDY-E3 (Lead (Pb)-Free) Si4835BDY-T1-E3 (Lead (Pb)-Free with Tape and Reel)

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	-30		v	
Gate-Source Voltage		V <sub>GS</sub>	±25			
Continuous Drain Current (T, = 150°C) <sup>a</sup>	$T_A = 25^{\circ}C$	- I <sub>D</sub>	-9.6	-7.4	А	
	$T_A = 70^{\circ}C$		-7.7	-5.9		
Pulsed Drain Current		I <sub>DM</sub>	-50		~	
continuous Source Current (Diode Conduction) <sup>a</sup>		Is	-2.1	-1.3		
Manimum Dauran Diania Aira 9	$T_A = 25^{\circ}C$	- P <sub>D</sub>	2.5	1.5	W	
Maximum Power Dissipation <sup>a</sup>	$T_A = 70^{\circ}C$		1.6	0.9		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	$t \le 10 \text{ sec}$	R <sub>thJA</sub>	39	50		
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		70	85	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	18	22		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

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SPECIFICATIONS (T <sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)									
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit			
Static									
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-1.0		-3.0	V			
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm25$ V			±100	nA			
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55^{\circ}\text{C}$			-1 -5	μΑ			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \leq -5$ V, $V_{GS}$ = -10 V	-50			А			
	r <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}, \ \text{I}_{D} = -9.6 \text{ A}$		0.014	0.018	Ω			
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -7.5 \text{ A}$		0.023	0.030				
Forward Transconductance <sup>a</sup>	9fs	$V_{DS} = -15 V$ , $I_{D} = -9.6 A$		30		S			
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{S} = -2.1 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V			
Dynamic <sup>b</sup>									
Total Gate Charge	Qg			25	37	nC			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = –15 V, $V_{GS}$ = –5 V, $I_{D}$ = –9.6 A		6.5					
Gate-Drain Charge	Q <sub>gd</sub>			12.5					
Gate Resistance	Rg		1.0	2.9	4.9	Ω			
Turn-On Delay Time	t <sub>d(on)</sub>			15	25				
Rise Time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 15 \Omega$		13	20	ns			
Turn-Off Delay Time	t <sub>d(off)</sub>	$\label{eq:VDD} \begin{array}{l} V_{DD} = -15 \text{ V}, \ R_L = 15 \ \Omega \\ I_D \ \cong \ -1 \ A, \ V_{GEN} = -10 \ V, \ R_g = 6 \ \Omega \end{array}$		60	100				
Fall Time	t <sub>f</sub>			45	70				
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -2.1 A, di/dt = 100 A/μs		45	80				

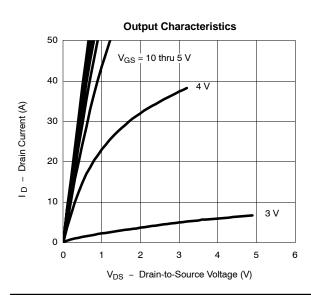
Notes

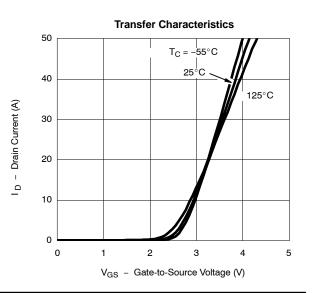
a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

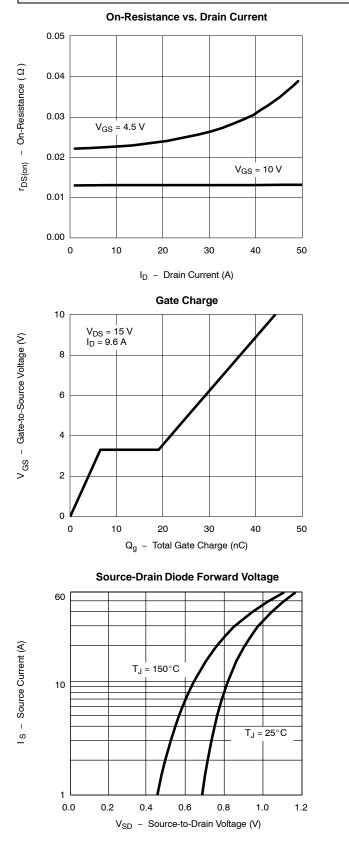


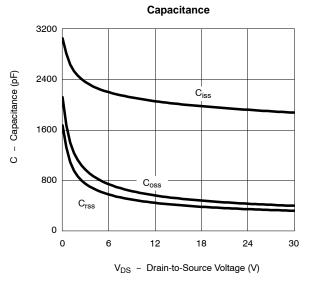




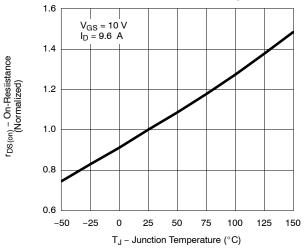
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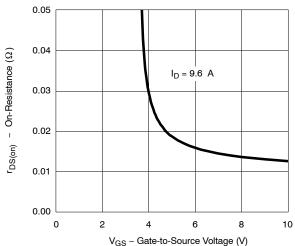




**On-Resistance vs. Junction Temperature** 



On-Resistance vs. Gate-to-Source Voltage

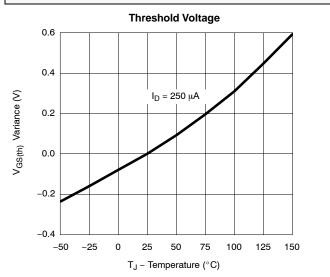


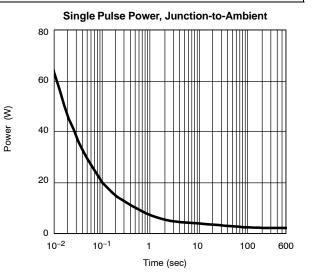
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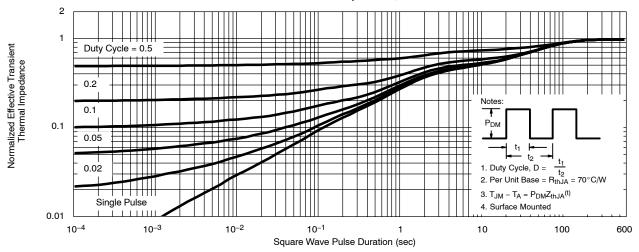
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Safe Operating Area 100 I<sub>DM</sub> Limited 1 1 1 1 1 1 \*r<sub>DS(on)</sub> Limited P(t) = 0.000110 P(t) = 0.001 ID - Drain Current (A) +++++++P(t) = 0.01 I<sub>D(on)</sub> 1 Limitéd P(t) = 0.1 P(t) = 1 T<sub>A</sub> = 25°C 1.1.1 0.1 P(t) = 10 Single Pulse dc BV<sub>DSS</sub> Limited 0.01 0.1 10 100 1  $V_{DS}$  – Drain-to-Source Voltage (V)  $^{\star}V_{GS}$  > minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

Normalized Thermal Transient Impedance, Junction-to-Ambient

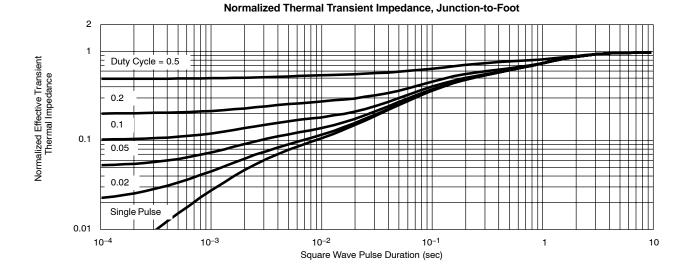


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#### **TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?72029">http://www.vishay.com/ppg?72029</a>.



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